

3.0Amp Surface Mounted Schottky Barrier Rectifiers

Features

- I_o 3A
- V_{RRM} 20V-200V
- Low forward voltage drop
- High surge current capability
- Metal silicon junction, majority carrier conduction

Mechical Data

- Case: SMAF molded plastic
- Molding compound: UL flammability classification rating 94V-0
- Terminals: Solder plated, solderable per MIL- STD-202, Method 208
- Polarity: Color band denotes cathode end

SMAF



Dimensions in inches and (millimeters)

Limiting Values (Absolute Maximum Rating)

Item	Symbol	Unit	Test Conditions	20TF	30TF	40TF	50TF	60TF	80TF	100TF	150TF	200TF
Repetitive Peak Reverse Voltage	V _{RRM}	V		20	30	40	50	60	80	100	150	200
Maximum RMS Voltage	V _{RMS}	V		14	21	28	35	42	56	70	105	140
Maximum DC Blocking Voltage	V _{DC}	V		20	30	40	50	60	80	100	150	200
Average Forward Current	I _{F(AV)}	A	60HZ Half-sine wave, Resistance load, TL(Fig.1)	3.0								
Surge(Non-repetitive)Forward Current	I _{FSM}	A	60Hz Half-sine wave ,1 cycle , Ta =25℃	70								
Junction Temperature	T _J	℃		-55~+125			-55~+150					
Storage Temperature	T _{STG}	℃		-55 ~ +150								

Ordering Information

Part Number	Package	Shipping Quantity
AS3G20-200TF	SMAF	3000/tape&Reel

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Electrical Characteristics ($T_a=25^\circ\text{C}$ Unless otherwise specified)

Item	Symbol	Unit	Test Condition		20TF	30TF	40TF	50TF	60TF	80TF	100TF	150TF	200TF
Peak Forward Voltage	V _F	V	I _F =3.0A		0.55			0.70		0.85		0.95	
Peak Reverse Current	I _{RRM1}	mA	V _{RM} =V _{RRM}	T _a =25℃	0.5					0.1			
	T _a =100℃			10					5.0				
Thermal Resistance(Typical)	R _{θJA}	℃/W	Between junction and ambient		78								
	Between junction and terminal		20										
	Between junction and case		18										
Juction Capacitance (Typical)	Cj	pF	Measured at 1.0MHz and applied reverse voltage of 4.0 volts.		140			120		100		50	

Typical Characteristics

FIG.1: FORWARD CURRENT DERATING CURVE

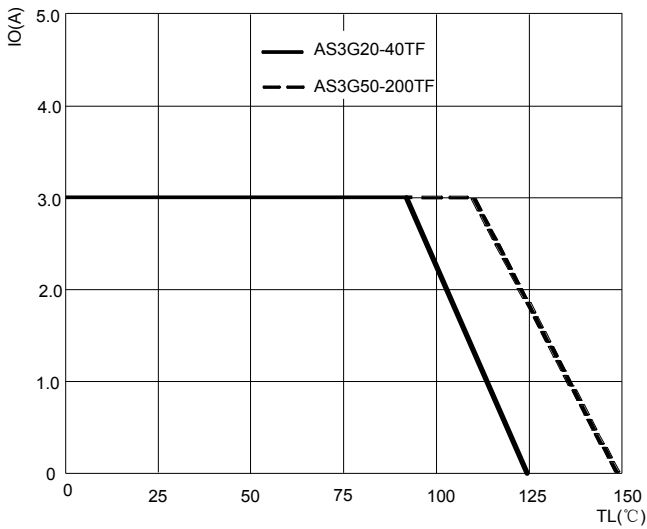


FIG2: Surge Forward Current Capability

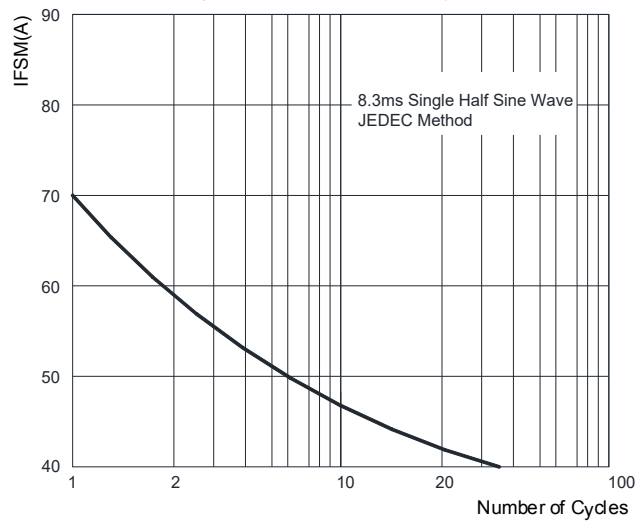


FIG.3: TYPICAL FORWARD CHARACTERISTICS

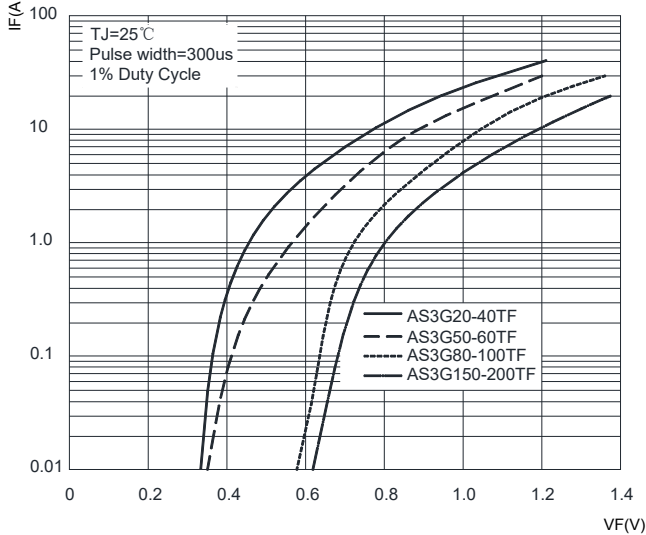
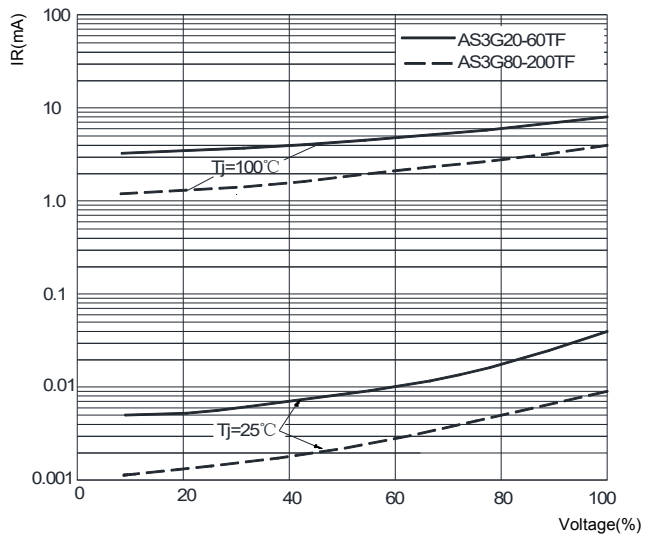
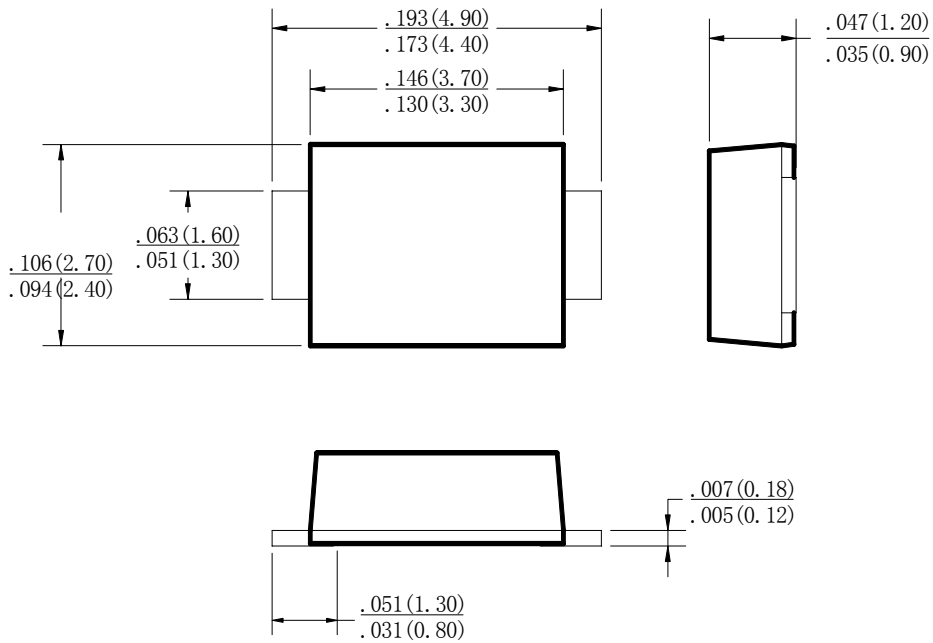


FIG 4: TYPICAL REVERSE CHARACTERISTICS



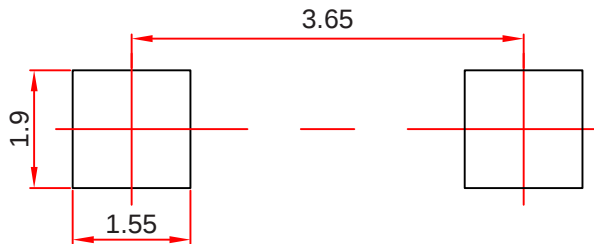
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SMAF Package Outline Dimensions



Dimensions in inches and (millimeters)

SMAF Suggested Pad Layout



Note:

1. Controlling dimension: in millimeters.
2. General tolerance: $\pm 0.05\text{mm}$.
3. The pad layout is for reference purposes only.

Marking Diagram



X: From 2 To 20

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Reel Taping Specifications For Surface Mount Devices- SMAF

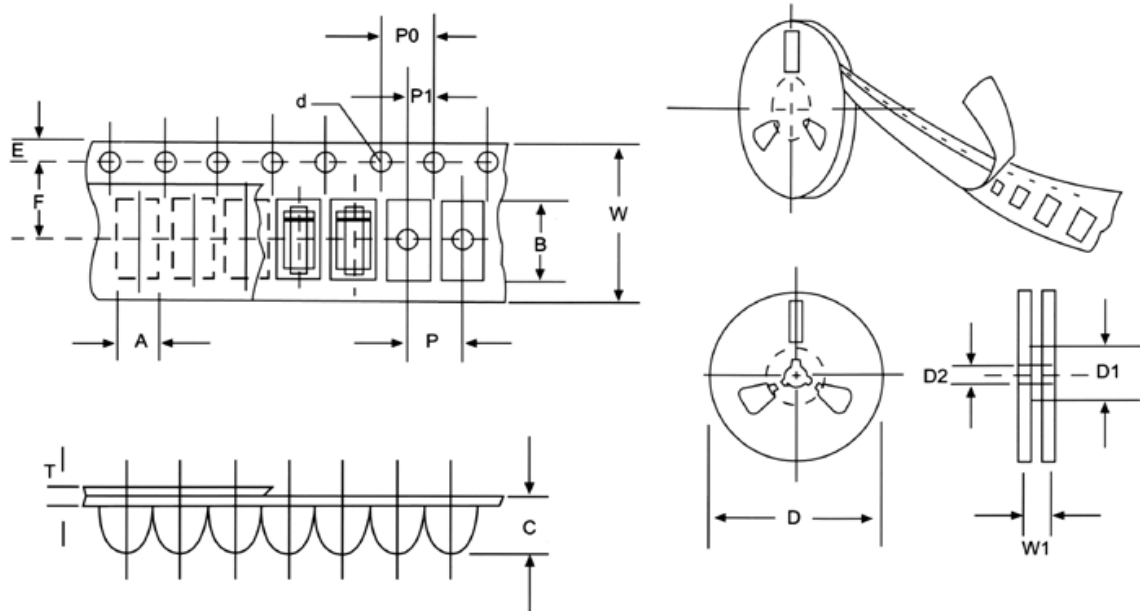


FIG : CONFIGURATION OF SURFACE MOUNTED DEVICES TAPING

ITEM	SYMBOL	SMAF mm(inch)
Carrier width	A	2.83+0.1(0.112+0.004)
Carrier length	B	4.90+0.1(0.193+0.004)
Carrier depth	C	1.45+0.1(0.057+0.004)
Sprocket hole	d	1.55+0.05(0.061+0.002)
Reel outside diameter	D	178+2.0(7.0+0.079)
Reel inner diameter	D1	54±1.0(2.13±0.039)
Feed hole diameter	D2	13+0.5(0.512+0.020)
Stroket hole position	E	1.75+0.1(0.069+0.004)
Punch hole position	F	5.5+0.05(0.217+0.002)
Punch hole pitch	P	4.0+0.1(0.157+0.004)
Sprocket hole pitch	P0	4.0+0.1(0.157+0.004)
Embossment center	P1	2.0+0.1(0.079+0.004)
Totall tape thickness	T	0.23-0.29(0.009-0.011)
Tape width	W	12.0+0.1(0.472+0.004)
Reel width	W1	16.8+2.0(0.661+0.079)

NOTE: Devices are packde in accordance with EIA standard RS-481-A and specification given above.